

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCS008D
DEPT.	For CS10 Series Connector System	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject DIP socket when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

MIL - STD - 1344 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CS10 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings



REVIEWED: <u>Alex</u> APPROVED: <u>David</u> VERIFIED: <u>Sandy</u> .



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current		1A
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than 10 mΩ
7.3	Dielectric strength	When applied AC 1000 V 1minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{ M}\Omega$
7.5	Working Voltage		150V DC max.

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Push pin from insulator base at speed 25±3 mm per minute	More than 3.4 Kgf
8.2	Single contact insertion force	Mating speed 25 mm/minute Force with 0.46 diameter test pin	250 gram max.
8.3	Single contact withdrawal force	Unmating speed 25 mm/minute Force with 0.46 diameter test pin	50 gram min.
8.4	Durability	Connector shall be subject to 100 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X,Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Solder ability	Soldering time: 5±0.5 second Soldering pot: 230±5°C	Minimum: 90% of immersed area
9.4	Resistance to soldering heat	Soldering time: 5±0.5 second Soldering pot: 260±5°C	No damage
9.5	Heat aging	105±2°C, 96 hours	No damage
9.6	Humidity	40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial
			Dielectric strength: To pass para 7-3



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	ITEM	TEST CONDITION	REQUIREMENT
9.7	Temperature cycling	One cycle consists of: (1)-55 +0 °C, 30 min. (2)Room temp. 10-15 min. (3) 85 +3 °C, 30 min.	Appearance: No damage Contact resistance: Less than twice of initial
		(4)Room temp. 10-15 min.	
9.8	Salt spray	Temperature: 35±3°C Solution: 5±1% Spray time: 48±4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -40 to + 105°C